

Device Features

- Typical Isolation = 24 dB
- Typical Insertion Loss = 0.7dB
- MSL 3 moisture rating
- Small Size and Low Profile
- RoHS2-compliant SOT-26 Plastic Package



BD18XX(XX=Wafer number)

Product Description

BeRex's Divider BD1826 is designed for PCS, WCDMA & TD-SCDMA band with low Insertion Loss and Isolation. This chip is fully passivated for enhanced performance and reliability and packaged in RoHS2-compliant with SOT-26 surface mount package.

Typical Performance¹

Parameter	Min	Typical	Max	Unit
Frequency Range	1700		2300	MHz
Insertion Loss		0.7	0.9	dB
Isolation	15	24		dB
IRL(S11)		-15	-11	dB
ORL(S22/S33)		-23	-19	dB
Amplitude Balance		0.07	0.2	dB
Phase Balance		1.5	2.0	deg

*All specifications apply to the following test conditions,

1. Device performance _ measured on BeRex E/B at 25°C, 50ohm system.

2. Insertion Loss: Above 3.0dB.

Applications

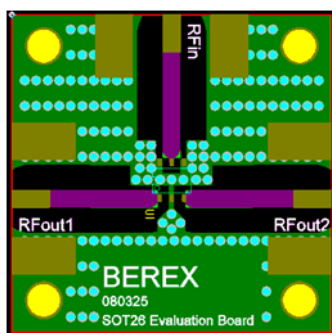
- Base station Infrastructure
- Commercial/Industrial/Military wireless system

Absolute Maximum Ratings

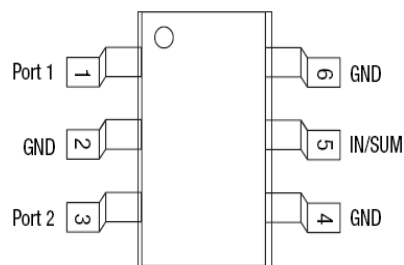
Parameter	Rating
Input Power	1W CW
Storage Temperature	-55 to +155°C
Operating Temperature	-40 to +85°C

Operation of this device above any of these parameters may result in permanent damage.

Evaluation Board Drawing



Function Block Diagram

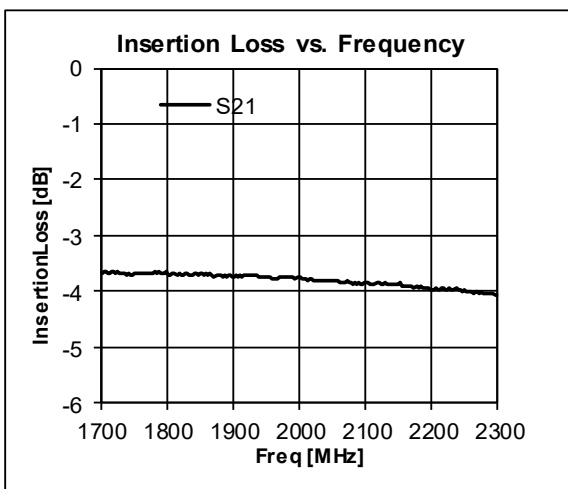


Pins 2,4 and 6 must be DC and RF grounded.

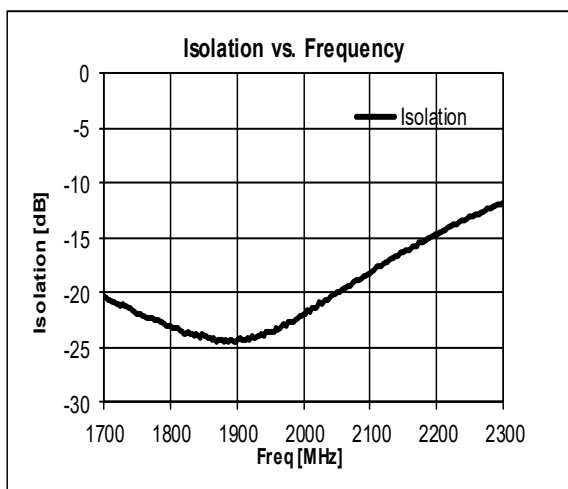
Typical Test Data

Parameters	Unit	PCS, WCDMA & TD-SCDMA				
Frequency Range	MHz	1700	1800	1900	2075	2250
Insertion Loss	dB	0.64	0.66	0.73	0.83	0.9
Isolation	dB	20.1	22.1	24.1	21.2	15.1
IRL(S11)	dB	-16.1	-16.3	-15.6	-13.5	-11.6
ORL(S22,S33)	dB	-23.2	-23.3	-23.1	-22.5	-20.5
Phase Diff.	deg	1.4	1.5	1.5	1.5	1.4
Amplitude Balance	dB	0.04	0.07	0.07	0.06	0.06

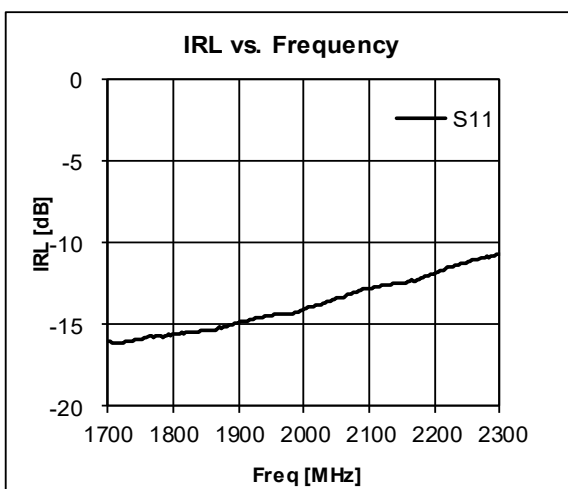
Insertion Loss vs. Frequency



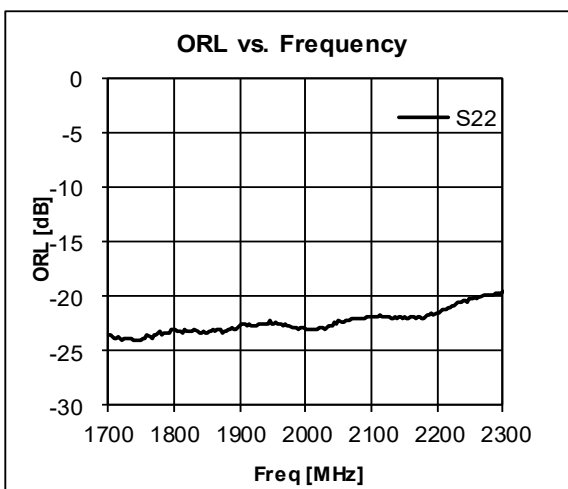
Isolation vs. Frequency



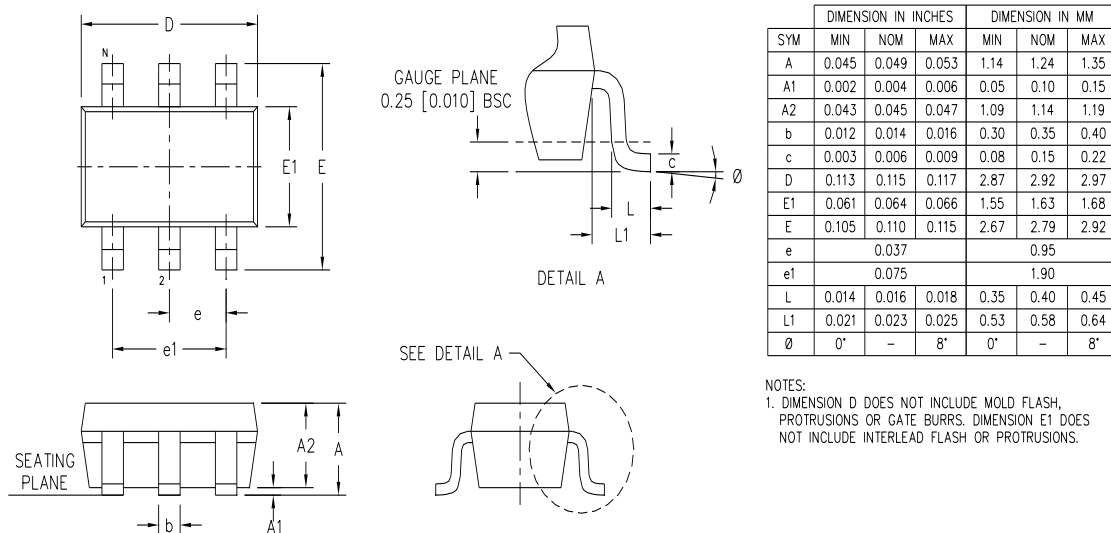
IRL vs. Frequency



ORL vs. Frequency

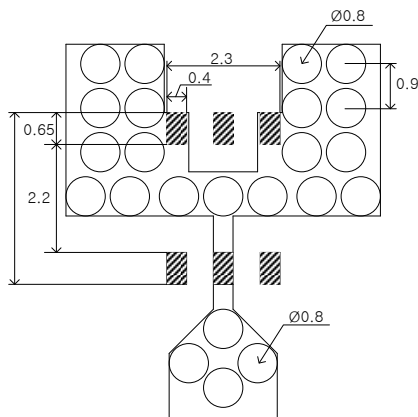


Package Outline Drawing

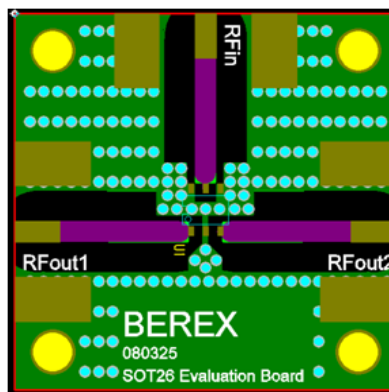


Suggested PCB Land Pattern and PAD Layout

PCB Land Pattern



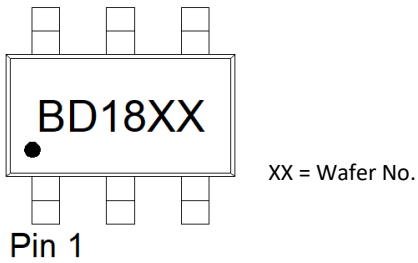
PCB Mounting



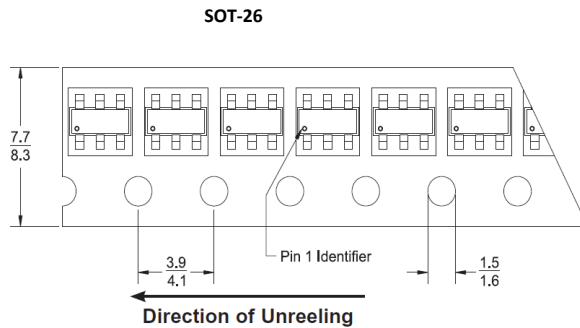
Note : All dimension _ millimeters

PCB lay out _ on BeRex website

Package Marking



Tape & Reel



Packaging information:

Tape Width (mm): 8
 Reel Size (inches): 7
 Device Cavity Pitch (mm): 4
 Devices Per Reel: 2000

Lead plating finish

100% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)

MSL / ESD Rating

MSL Rating: Level 3 at +260°C convection reflow

Standard: JEDEC Standard J-STD-020



Proper ESD procedures should be followed when handling this device.

RoHS Compliance

This part is compliant with Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) Directive 2011/65/EU as amended by Directive 2015/863/EU.

This product also is compliant with a concentration of the Substances of Very High Concern (SVHC) candidate list which are contained in a quantity of less than 0.1%(w/w) in each components of a product and/or its packaging placed on the European Community market by the BeRex and Suppliers.

NATO CAGE code:

2	N	9	6	F
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